

NVMFS5885NLT1G Datasheet



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DiGi Electronics Part Number NVMFS5885NLT1G-DG

Manufacturer onsemi

Manufacturer Product Number NVMFS5885NLT1G

Description MOSFET N-CH 60V 10.2A 5DFN

Detailed Description N-Channel 60 V 10.2A (Ta) 3.7W (Ta), 54W (Tc) Surf

ace Mount 5-DFN (5x6) (8-SOFL)



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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
NVMFS5885NLT1G	onsemi
Series:	Product Status:
	Obsolete
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
60 V	10.2A (Ta)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ Id, Vgs:
4.5V, 10V	15mOhm @ 15A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
2.5V @ 250µA	21 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	1340 pF @ 25 V
FET Feature:	Power Dissipation (Max):
	3.7W (Ta), 54W (Tc)
Operating Temperature:	Grade:
-55°C ~ 175°C (TJ)	Automotive
Qualification:	Mounting Type:
AEC-Q101	Surface Mount
Supplier Device Package:	Package / Case:
5-DFN (5x6) (8-SOFL)	8-PowerTDFN, 5 Leads
Base Product Number:	
NVMFS5885	

Environmental & Export classification

8541.29.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	

MOSFET – Power, Single N-Channel 60 V, 15 mΩ, 39 A

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- NVMFS5885NLWF Wettable Flanks Product
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	60	V
Gate-to-Source Voltage	9		V _{GS}	±20	V
Continuous Drain Cur-		T _{mb} = 25°C	I _D	39	Α
rent R $_{\Psi J-mb}$ (Notes 1, 2, 3)	Steady	T _{mb} = 100°C		28	
Power Dissipation	State	T _{mb} = 25°C	P _D	54	W
R _{ΨJ-mb} (Notes 1, 2, 3)		T _{mb} = 100°C		27	
Continuous Drain Cur-		T _A = 25°C	I _D	10.2	Α
rent R _{θJA} (Notes 1 & 3)	Steady	T _A = 100°C		7.2	
Power Dissipation	State	T _A = 25°C	P_{D}	3.7	W
R _{θJA} (Notes 1 & 3)		T _A = 100°C		1.8	
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	179	Α
Operating Junction and Storage Temperature			T _J , T _{stg}	-55 to 175	°C
Source Current (Body Diode)			I _S	46	Α
Single Pulse Drain-to-Source Avalanche Energy (T _J = 25°C, V _{DD} = 50 V, V _{GS} = 10 V, $I_{L(pk)}$ = 18 A, L = 0.3 mH, R_G = 25 Ω)			E _{AS}	49	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Mounting Board (top) - Steady State (Notes 2, 3)	$R_{\Psi J-mb}$	2.8	°C/W
Junction-to-Ambient - Steady State (Note 3)	$R_{\theta JA}$	41	

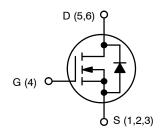
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Psi (Ψ) is used as required per JESD51-12 for packages in which substantially less than 100% of the heat flows to single case surface.
- 3. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.



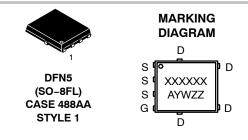
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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	15 mΩ @ 10 V	00.4
60 V	21 mΩ @ 4.5 V	39 A



N-CHANNEL MOSFET



A = Assembly Location

Y = Year
W = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

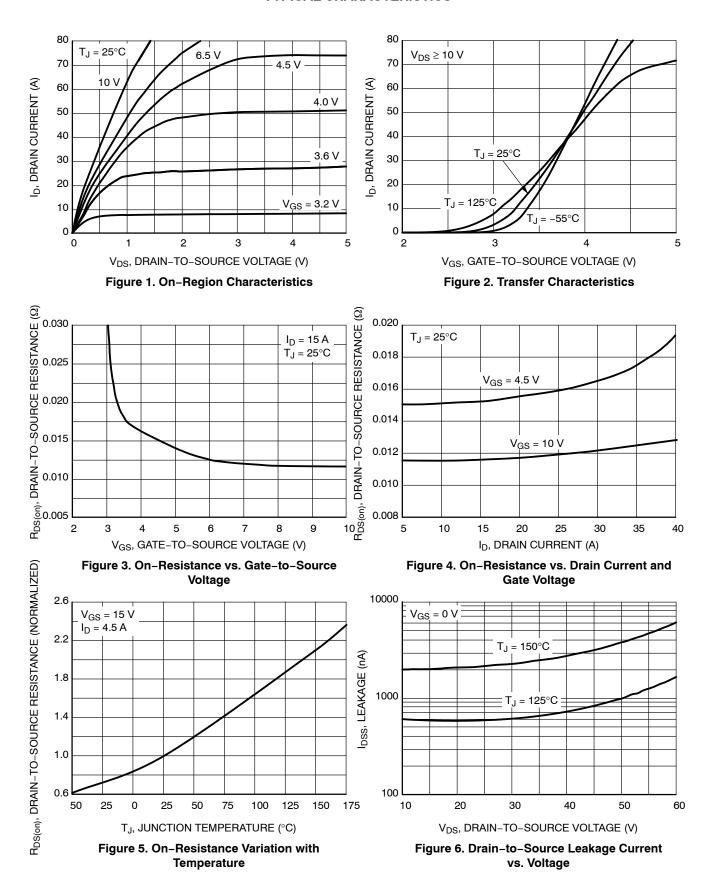
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Con	Test Condition		Тур	Max	Unit
OFF CHARACTERISTICS	•	•	•			•	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	Voc = 0 V T _J = 25°C			1.0	μΑ
		V _{DS} = 60 V	T _J = 125°C			10	-
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{G}$	_S = ± 20 V			±100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{DS}$) = 250 μΑ	1.5		2.5	V
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V,	I _D = 15 A		11.6	15	mΩ
		V _{GS} = 4.5 V,	I _D = 15 A		15.2	21	-
CHARGES AND CAPACITANCES	•		•			•	
Input Capacitance	C _{iss}	V _{GS} = 0 V, f	= 1 MHz,		1340		pF
Output Capacitance	C _{oss}	V _{DS} = 25 V			125		
Reverse Transfer Capacitance	C _{rss}				85		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 48 V, I _D = 15 A			12		
Threshold Gate Charge	Q _{G(TH)}				1.1		1 _
Gate-to-Source Charge	Q _{GS}				4.0		nC
Gate-to-Drain Charge	Q_{GD}				6.3		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} =	48 V, I _D = 15 A		21		nC
SWITCHING CHARACTERISTICS (No	ote 5)				•	•	
Turn-On Delay Time	t _{d(ON)}				10		
Rise Time	t _r	V _{GS} = 4.5 V, V	ns = 48 V.		64		
Turn-Off Delay Time	t _{d(OFF)}	$I_D = 15 \text{ A}, R_C$			18		ns
Fall Time	t _f				52		
DRAIN-SOURCE DIODE CHARACTER	RISTICS				•	•	
Forward Diode Voltage	V_{SD}	$V_{GS} = 0 V$	T _J = 25°C		0.8	1.2	V
		I _S = 15 A	T _J = 125°C		0.7		
Reverse Recovery Time	t _{RR}		<u>'</u>		20		
Charge Time	t _a	$V_{GS} = 0 V, dls/d$	t = 100 A/us.		15		ns
Discharge Time	t _b	l _S = 15 A			5.0		1
Reverse Recovery Charge	Q _{RR}				16		nC

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

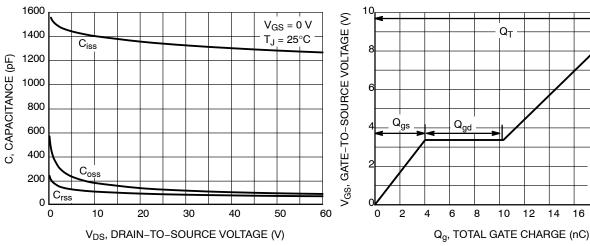


Figure 7. Capacitance Variation

Figure 8. Gate-to-Source Voltage vs. Total Charge

 $V_{DS} = 48 A$ $I_{D} = 15 A$

T_J = 25°C

20

18

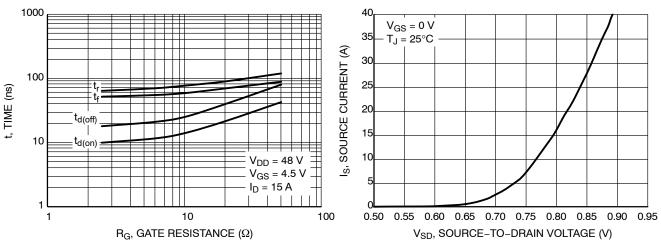


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

Figure 10. Diode Forward Voltage vs. Current

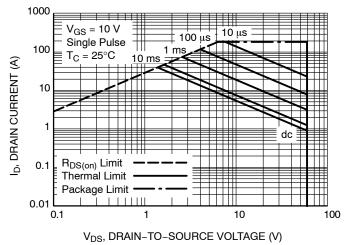


Figure 11. Maximum Rated Forward Biased Safe Operating Area

TYPICAL CHARACTERISTICS

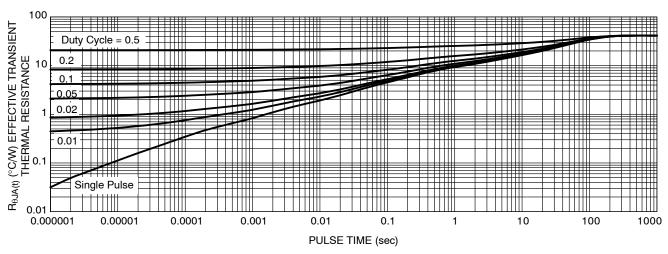


Figure 12. Thermal Response

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFS5885NLT1G	V5885L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5885NLWFT1G	5885LW	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5885NLT3G	V5885L	DFN5 (Pb-Free)	5000 / Tape & Reel
NVMFS5885NLWFT3G	5885LW	DFN5 (Pb-Free)	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS



DFN5 5x6, 1.27P (SO-8FL) CASE 488AA **ISSUE N**

DATE 25 JUN 2018

NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSION D1 AND E1 DO NOT INCLUDE
- MOLD FLASH PROTRUSIONS OR GATE BURRS

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.90	1.00	1.10	
A1	0.00		0.05	
b	0.33	0.41	0.51	
С	0.23	0.28	0.33	
D	5.00	5.15	5.30	
D1	4.70	4.90	5.10	
D2	3.80	4.00	4.20	
E	6.00	6.15	6.30	
E1	5.70	5.90	6.10	
E2	3.45	3.65	3.85	
е	1.27 BSC			
G	0.51	0.575	0.71	
K	1.20	1.35	1.50	
L	0.51	0.575	0.71	
L1	0.125 REF			
М	3.00	3.40	3.80	
θ	0 °		12 °	

GENERIC MARKING DIAGRAM*

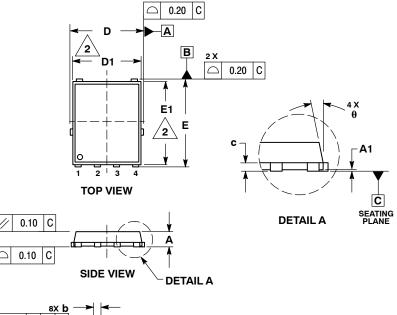


XXXXXX = Specific Device Code

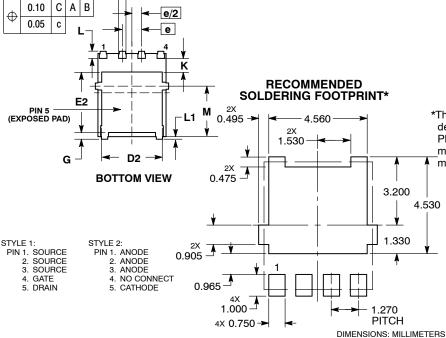
= Assembly Location Α

Υ = Year W = Work Week = Lot Traceability ZZ

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.



2 X



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	DFN5 5x6, 1.27P (SO-8FL)		PAGE 1 OF 1	

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